## UNITRロロE

## High Current FET Driver

## FEATURES

- Totem Pole Output with 6A Source/Sink Drive
- 3ns Delay
- 20ns Rise and Fall Time into 2.2nF
- 8ns Rise and Fall Time into 30nF
-4.7V to 18 V Operation
- Inverting and Non-Inverting Outputs
- Under-Voltage Lockout with Hysteresis
- Thermal Shutdown Protection
- MINIDIP and Power Packages


## DESCRIPTION

The UC1710 family of FET drivers is made with a high-speed Schottky process to interface between low-level control functions and very high-power switching devices-particularly power MOSFET's. These devices accept low-current digital inputs to activate a high-current, totem pole output which can source or sink a minimum of 6 A .

Supply voltages for both $\mathrm{V}_{\mathrm{IN}}$ and $\mathrm{V}_{\mathrm{C}}$ can independently range from 4.7 V to 18 V . These devices also feature under-voltage lockout with hysteresis.
The UC1710 is packaged in an 8-pin hermetically sealed dual in-line package for $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ operation. The UC2710 and UC3710 are specified for a temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ respectively and are available in either an 8 -pin plastic dual in-line or a 5 -pin, TO-220 package. Surface mount devices are also available.

ORDERING INFORMATION

## TRUTH TABLE

|  |  |  |
| :---: | :---: | :---: |
| INV | N.I. | Out |
| $H$ | $H$ | $L$ |
| $L$ | $H$ | $H$ |
| $H$ | $L$ | $L$ |
| $L$ | $L$ | $L$ |
|  |  |  |
|  |  |  |
| OUT $=\overline{I N V}=I N V$ or $\overline{N . I . I . ~}$ |  |  |


|  | TEMPERATURE RANGE | PACKAGE |
| :---: | :---: | :---: |
| UC1710J | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8 pin CDIP |
| UC2710DW | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16 pin SOIC-wide |
| UC2710J |  | 8 pin CDIP |
| UC2710N |  | 8 pin PDIP |
| UC2710T |  | 5 pin TO220 |
| UC3710DW | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16 pin SOIC-wide |
| UC3710N |  | 8 pin PDIP |
| UC3710T |  | 5 pin TO220 |

## BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

|  | N-Package | J-Package | T-Package |
| :---: | :---: | :---: | :---: |
| Supply Voltage, Vin | 20 V | 20V | 20V |
| Collector Supply Voltage, $\mathrm{V}_{\mathrm{C}}$ | 20 V | 20V | 20V |
| Operating Voltage | 18 V | 18V | 18 V |
| Output Current (Source or Sink) |  |  |  |
| Steady-State. . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 500 \mathrm{~mA}$. . . . . . . . . . . $\pm$ 500mA . . . . . . . . . . . . . $\pm$ 1A |  |  |  |
| Digital Inputs . . . . . . . . . . . . . . . . . . . . . . . . -0.3V-VIN . . . . . . . -0.3V - VIN . . . . . . . . -0.3 V - $\mathrm{V}^{\text {VIN }}$ |  |  |  |
| Power Dissipation at $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  |  |  |
| Power Dissipation at T (Case) = $25^{\circ} \mathrm{C}$. . . . . . . . . . . . 2W . . . . . . . . . . . . . . . 2W . . . . . . . . . . . . . 25W |  |  |  |
| Operating Junction Temperature . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C} \ldots . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C} \ldots . .55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
| Storage Temperature . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C} \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C} \ldots . . .65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
| Lead Temperature (Soldering, 10 seco | $300^{\circ} \mathrm{C}$ | $300^{\circ} \mathrm{C}$ | $300^{\circ} \mathrm{C}$ |

Note 1: All currents are positive into, negative out of the specified terminal.
Note 2: Consult Unitrode Integrated Circuits databook for information regarding thermal specifications and limitations of packages.

## CONNECTION DIAGRAMS



ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for $\mathrm{V}_{\mathbb{I}}=\mathrm{V}_{\mathrm{C}}=15 \mathrm{~V}$, No load,
$T_{A}=T_{J}$.

| PARAMETERS | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| VIN Supply Current | $\mathrm{V}_{\text {IN }}=18 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}=18 \mathrm{~V}$, Output Low |  | 26 | 35 | mA |
|  | $\mathrm{V}_{\text {IN }}=18 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}=18 \mathrm{~V}$, Output High |  | 21 | 30 | mA |
| $\mathrm{V}_{\mathrm{C}}$ Supply Current | $\mathrm{V}_{\text {IN }}=18 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}=18 \mathrm{~V}$, Output Low |  | 1.5 | 5.0 | mA |
|  | $\mathrm{V}_{\text {IN }}=18 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}=18 \mathrm{~V}$, Output High |  | 5.0 | 8 | mA |
| UVLO Threshold | $\mathrm{V}_{\mathrm{IN}}$ High to Low | 3.8 | 4.1 | 4.4 | V |
|  | $\mathrm{V}_{\text {IN }}$ Low to High | 4.1 | 4.4 | 4.8 | V |

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for $\mathrm{V}_{\mathbb{I N}}=\mathrm{V}_{\mathrm{C}}=15 \mathrm{~V}$, No load, $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}$.

| PARAMETERS | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
| :--- | :--- | :---: | :---: | :---: | :---: |
| UVLO Threshold Hysteresis |  | 0.1 | 0.3 | 0.5 | V |
| Digital Input Low Level |  |  |  | 0.8 | V |
| Digital Input High Level |  | 2.0 |  |  | V |
| Digital Input Current | Digital Input $=0.0 \mathrm{~V}$ | -70 | -4.0 |  | $\mu \mathrm{~A}$ |
| Output High Sat., $\mathrm{V}_{\mathrm{C}}-\mathrm{V}_{\mathrm{O}}$ | $\mathrm{I}_{\mathrm{O}}=-100 \mathrm{~mA}$ |  | 1.35 | 2.2 | V |
|  | $\mathrm{I}_{\mathrm{O}}=-6 \mathrm{~A}$ |  | 3.2 | 4.5 | V |
| Output Low Sat., $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{I}_{\mathrm{O}}=100 \mathrm{~mA}$ |  | 0.25 | 0.6 | V |
| Thermal Shutdown | $\mathrm{I}_{\mathrm{O}}=6 \mathrm{~A}$ |  | 3.4 | 4.5 | V |

From Inv., Input to Output (Note 3, 4):

| Rise Time Delay | $C L=0$ | 35 | 70 | ns |
| :---: | :---: | :---: | :---: | :---: |
|  | $C L=2.2 n F$ | 35 | 70 | ns |
|  | $C L=30 \mathrm{FF}$ | 35 | 70 | ns |
| 10\% to 90\% Rise | $C L=0$ | 20 | 40 | ns |
|  | $C L=2.2 n F$ | 25 | 40 | ns |
|  | $C L=30 n F$ | 85 | 150 | ns |
| Fall Time Delay | $C L=0$ | 35 | 70 | ns |
|  | $C L=2.2 n F$ | 35 | 70 | ns |
|  | $C L=30 \mathrm{FF}$ | 35 | 80 | ns |
| 90\% to 10\% Fall | $C L=0$ | 15 | 40 | ns |
|  | $C L=2.2 n F$ | 20 | 40 | ns |
|  | $C L=30 n F$ | 85 | 150 | ns |

From N.I. Input to Output (Note 3,4):

| Rise Time Delay | $C L=0$ | 35 | 70 | ns |
| :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{CL}=2.2 \mathrm{nF}$ | 35 | 70 | ns |
|  | $C L=30 n F$ | 35 | 70 | ns |
| 10\% to 90\% Rise | $C L=0$ | 20 | 40 | ns |
|  | $\mathrm{CL}=2.2 \mathrm{nF}$ | 25 | 40 | ns |
|  | $\mathrm{CL}=30 \mathrm{nF}$ | 85 | 150 | ns |
| Fall Time Delay | $C L=0$ | 35 | 70 | ns |
|  | $\mathrm{CL}=2.2 \mathrm{nF}$ | 35 | 70 | ns |
|  | $\mathrm{CL}=30 \mathrm{nF}$ | 35 | 80 | ns |
| 90\% to 10\% Fall | $C L=0$ | 15 | 40 | ns |
|  | $\mathrm{CL}=2.2 \mathrm{nF}$ | 20 | 50 | ns |
|  | $\mathrm{CL}=30 \mathrm{nF}$ | 85 | 150 | ns |
| Total Supply Current at 200kHz Input Switching Frequency | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 5) $\mathrm{CL}=0$ | 30 | 40 | mA |

Note: 3. Delay measured from $50 \%$ input change to $10 \%$ output change.
Note: 4. Those parameters with $C L=30 \mathrm{nF}$ are not tested in production.
Note: 5. Inv. Input pulsed at 50\% duty cycle with N.I. Input = 3V. or N.I. Input pulsed at 50\% duty cycle with Inv. Input = OV.

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## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ${ }^{(2)}$ | Lead/ Ball Finish | MSL Peak Temp ${ }^{(3)}$ | Samples <br> (Requires Login) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 5962-0152001QPA | ACTIVE | CDIP | JG | 8 | 1 | TBD | Call TI | Call TI |  |
| 5962-0152001VPA | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type |  |
| 5962-0152001VXA | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type |  |
| UC1710J | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type |  |
| UC1710J883B | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg Type |  |
| UC1710L883B | OBSOLETE | TO/SOT | L | 20 |  | TBD | Call TI | Call TI |  |
| UC1710SP | OBSOLETE | CDIP | $J$ | 16 |  | TBD | Call TI | Call TI |  |
| UC2710N | ACTIVE | PDIP | P | 8 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | N / A for Pkg Type |  |
| UC2710NG4 | ACTIVE | PDIP | P | 8 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | N / A for Pkg Type |  |
| UC2710T | ACTIVE | TO-220 | KC | 5 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU SN | N / A for Pkg Type |  |
| UC2710TG3 | ACTIVE | TO-220 | KC | 5 | 50 | Green (RoHS \& no Sb/Br) | CU SN | N/ A for Pkg Type |  |
| UC3710DW | ACTIVE | SOIC | DW | 16 | 40 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-2-260C-1 YEAR |  |
| UC3710DWG4 | ACTIVE | SOIC | DW | 16 | 40 | Green (RoHS <br> \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-2-260C-1 YEAR |  |
| UC3710N | ACTIVE | PDIP | P | 8 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | N / A for Pkg Type |  |
| UC3710NG4 | ACTIVE | PDIP | P | 8 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | N/ A for Pkg Type |  |
| UC3710T | ACTIVE | TO-220 | KC | 5 | 50 | Green (RoHS \& no Sb/Br) | CU SN | N/ A for Pkg Type |  |
| UC3710TG3 | ACTIVE | TO-220 | KC | 5 | 50 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU SN | N/ A for Pkg Type |  |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
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Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
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## OTHER QUALIFIED VERSIONS OF UC1710, UC1710-SP, UC3710 :

- Catalog: UC3710, UC1710
- Military: UC1710
- Space: UC1710-SP


## NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application


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